

Crystal LTD TM SPEC Form

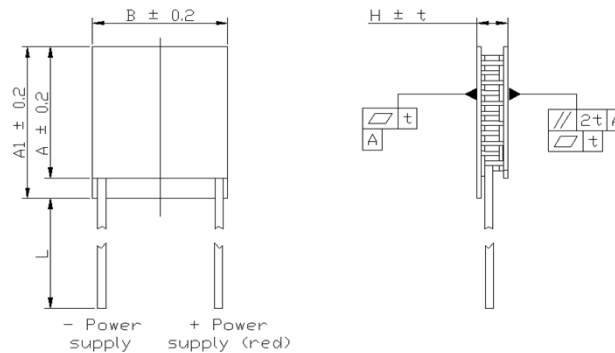
Customer

PO#  
PO date

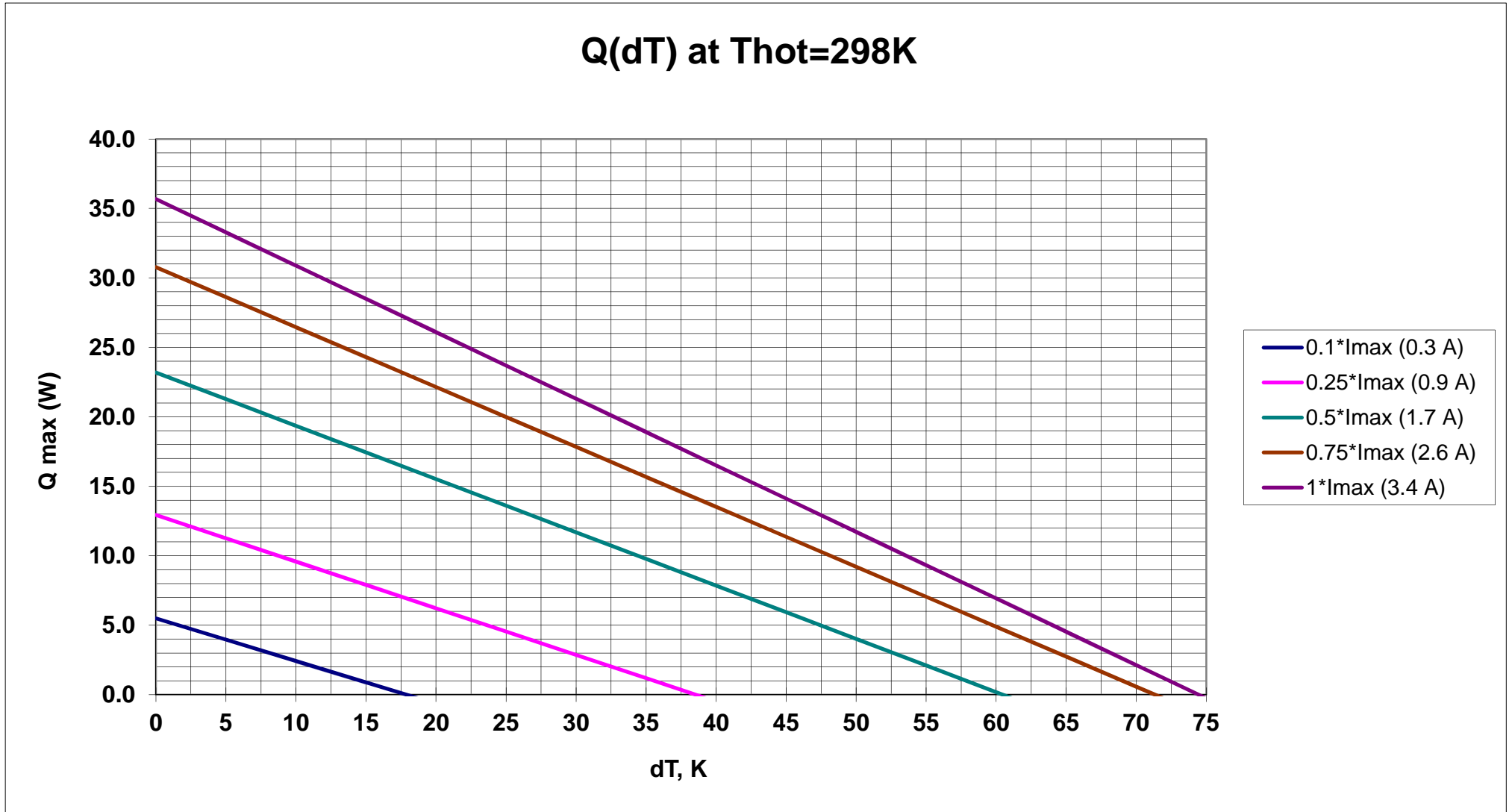
Thermoelectric module (TM) specification

PO position #	TM	Internal Solder Melting Temp, C	Max operating temperature, °C		Parameters in vacuum at hot side temperature 25 °C				Rac at 25 °C		Ceramic size, mm		TM Height		Wire			Sealing
			short time	continuous operation	I <sub>max</sub> , A	U <sub>max</sub> , V	Q <sub>max</sub> , W	dT <sub>max</sub> , K	Rac, Ohm	Tolerance ±, %	A/A1	B	Height, mm	Tolerance t, ± mm	S, AWG #	Length, mm	Tolerance ±, mm	
1	S-131-10-13-L2	138	130	115	3.4	16.7	35.7	74.5	3.66	10	40/40	23	3.60	0.02	24	100	5	
															PVC			

Clamping force: 15.8 - 31.6 kg



Max dT is reduced by 2-3K for silicon sealed and 1-2K for epoxy sealed versions.



### U(dT) at Thot=298K

